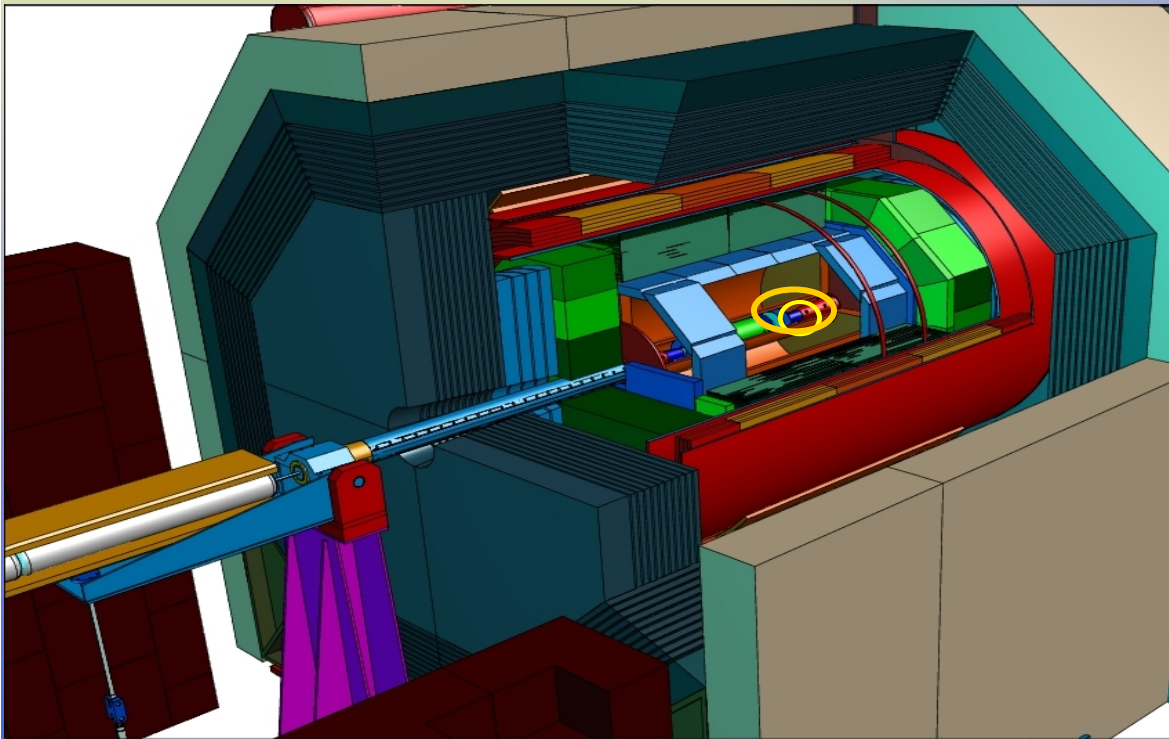


# TESLA Forward Calorimeters

## Recent Developments

L. Zawiejski INP PAS Cracow

International Conference on Linear Collider  
LCWS 2004, Paris, April 19 - 23 2004



Colorado  
Cracow  
Dubna  
London  
Minsk  
Moscow  
Prague  
Protvino  
Tel-Aviv

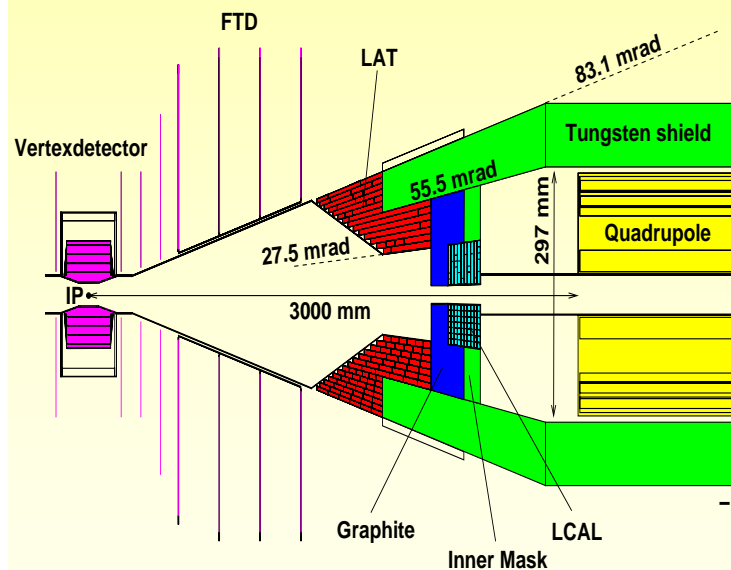
# Forward Region – LumiCal (LAT) and BeamCal (LCAL) Calorimeters

The main functions:

- Precision luminosity measurements (LumiCal) :  $\Delta L / L \approx 10^{-4}$
- Fast beam diagnostic + physics (BeamCal)
- Detection of electrons and photons at very small angles
- Shield of inner (tracking) detector
- Supplied maximum hermiticity

for Bhabha process  
 $e^+e^- \rightarrow e^+e^- (\gamma)$

New mask design

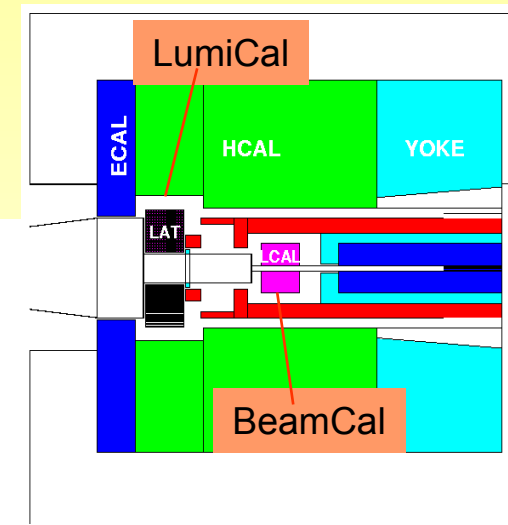


LumiCal

- $z = 305-325$  cm
- $r = 8-28$  cm
- $26.2 < \theta < 82$  mrad
- $0 < \varphi < 360$  deg

BeamCal

- $z = 365-385$  cm
- $R = 1.2-8$  cm
- $3.9 < \theta < 26.2$  mrad
- $0 < \varphi < 360$  deg



$L^* \approx 4$  m optics

Advantages:

- Reduce the leakage particles from LumiCal – help to achieve required precision in LUMI
- less fakes can scatter from mask into ECAL
- more space for electronics
- outer CAL better separated from beamstrahlung
- Shintake monitor can be used

TDR design:

$\Delta L/L$ :  $10^{-4}$  impossible  
 0.2 – 0.3 mrad accuracy

$\Delta \theta \sim$  a few  $\mu$ rad :  $\Delta L/L$   $10^{-4}$  possible

# LumiCal - Luminosity Measurement

## Monte Carlo Simulation -

Cracow

Optimisation of shape and structure are studied to reach  $\Delta L / L \sim 10^{-4}$ . Need laser alignment system

Si (sensor) / W calorimeter  
concentric cylinders (in r), sectors in ( $\phi$ ) and rings in (z)  
Si : pads or strips

### Realistic Monte Carlo

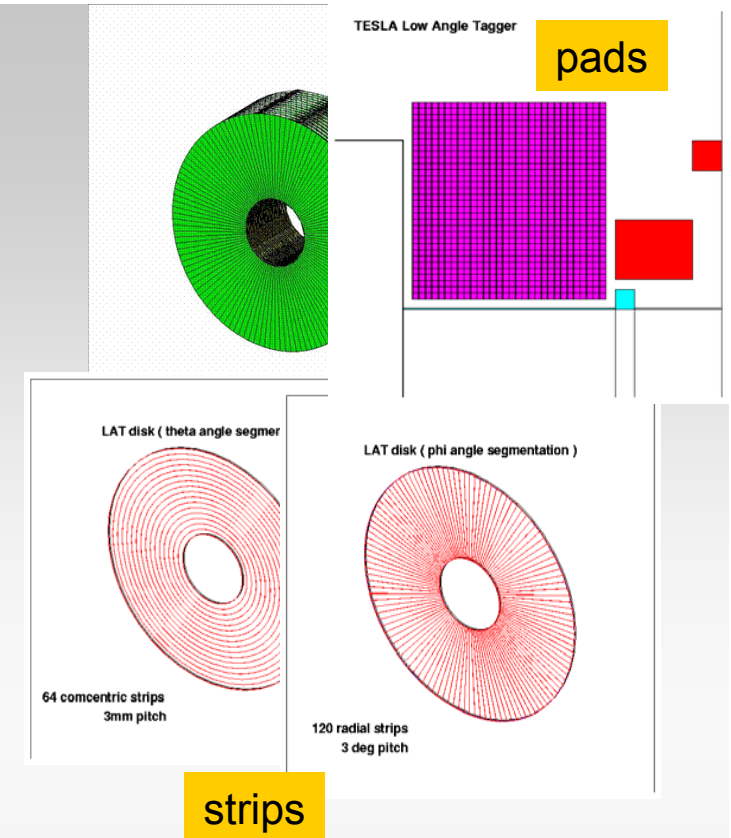
- rad. corrections (BHLUMI / BHWIDE) - Bhabha MC program
- beamstrahlung (CIRCE, Guinea-Pig  $\rightarrow e^-e^+$  pairs background)
- full detector simulation
- reconstruction of events

Possible LumiCal segmentation :

15 - 32 cylinders in r  
24 - 48 sectors in  $\phi$   
30 rings in z (readout from every 2nd)  
~ 11500 channels

Resolution:  $\sigma(\theta) \sim 70 - 90 \mu\text{rad}$  feasible  
possible improvement - reconstruction algorithm

Energy resolution:  $\sim 40\% \sqrt{E}$

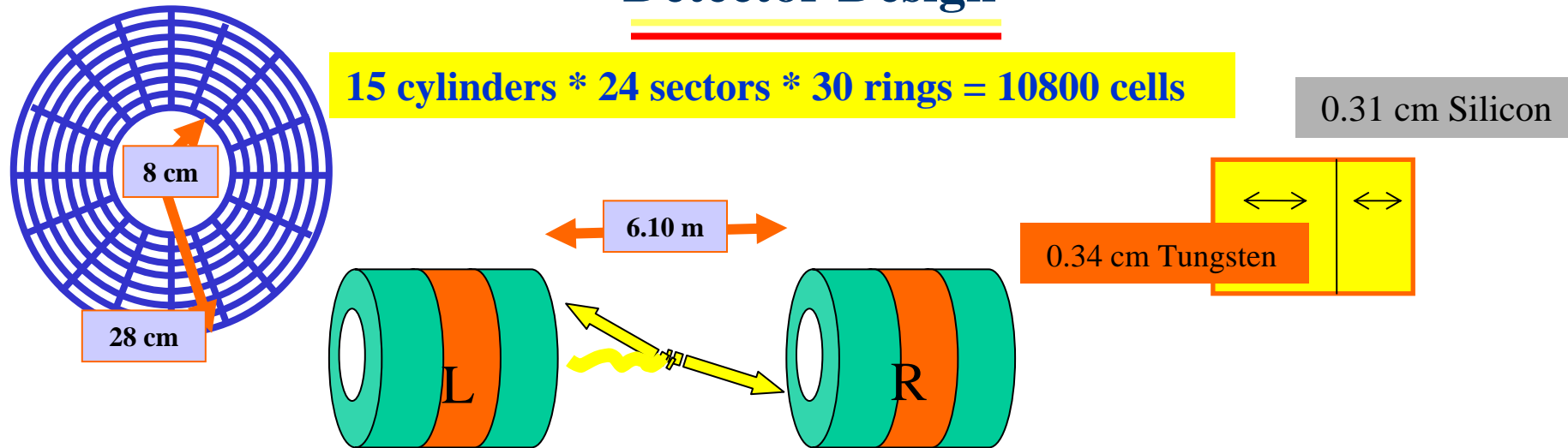


rings – 30 , every second ring –  
120 radial or 64 concentric strips  
~ 3000 readout channels

Resolution:  $\sigma(\theta) \sim 50 - 90 \mu\text{rad}$

Energy resolution:  $\sim 31 - 43 \% \sqrt{E}$

## Detector Design

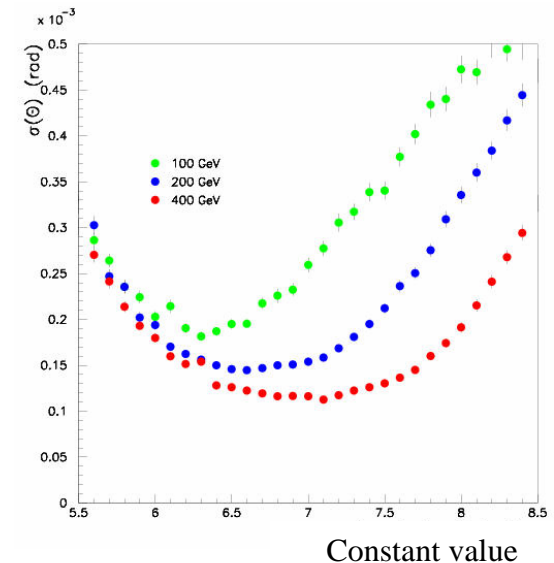
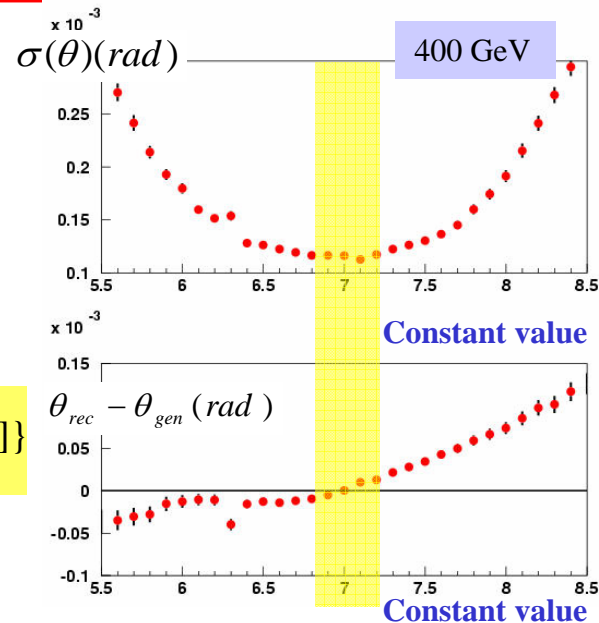


## Reconstruction Algorithm

$$\langle X \rangle = \frac{\sum X_i E_i}{\sum E_i}$$

$$\langle X \rangle = \frac{\sum X_i W_i}{\sum W_i}$$

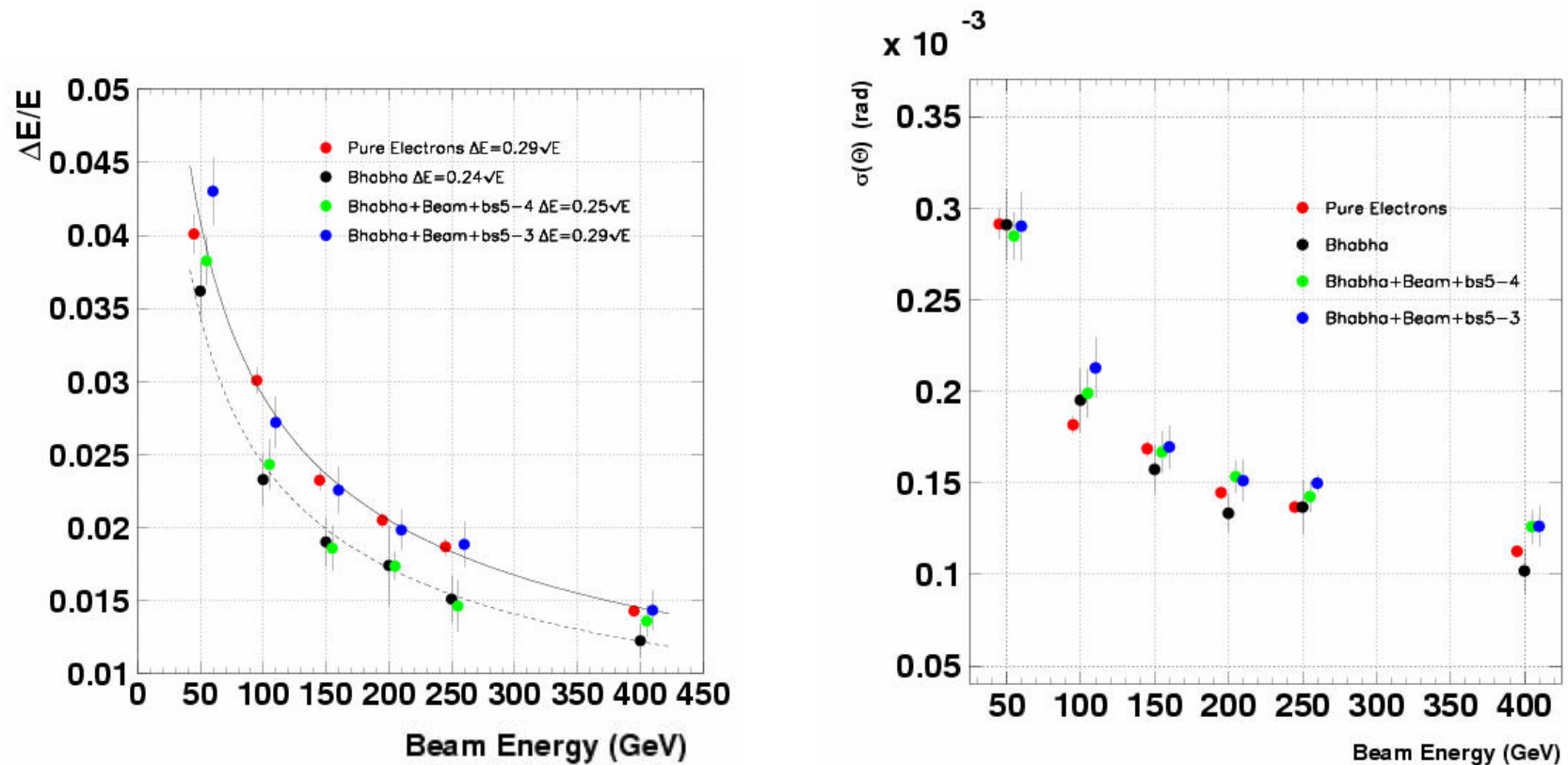
$$W_i = \max \{0, [\text{const}(E_{\text{beam}}) + \ln(\frac{E_i}{E_T})]\}$$



## Energy and Angular resolution

**Simulation:** BHWIDE (Bhabha)+CIRCE (Beamstrahlung)+beamspred

**Events selection:** acceptance, energy balance, azimuthal and angular symmetry.



Final choice of LumiCal sensor geometry ?

# BeamCal - Beam Monitoring

Beam monitoring - observation  $e^-e^+$  pairs from beamstrahlung which is sensitive to the machine parameters.

- pairs in BeamCal
- photons downstream

Severe conditions for work:

thousands pairs ( $\sim 15000$  hits) per BX

- large energy deposition 10 – 20 TeV

hard radiation

- 10 MGy per year. Required rad. hard sensors

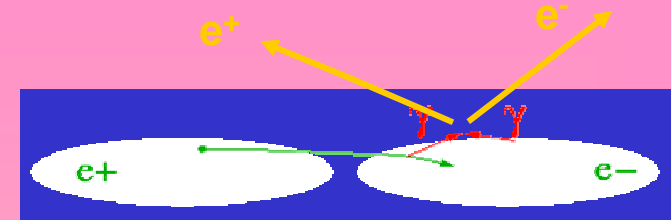
In cold technology:

large bunch spacing

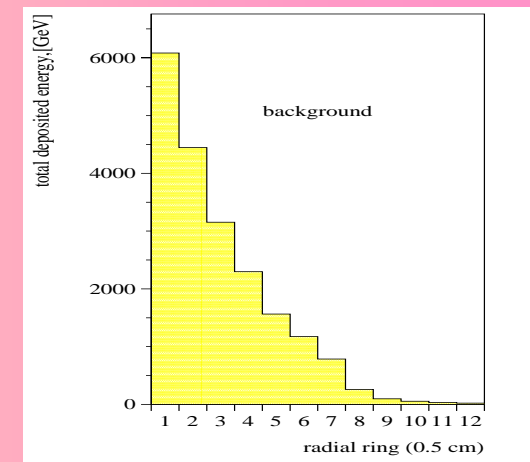
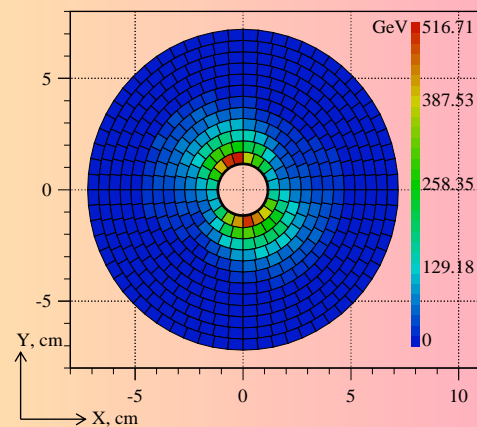
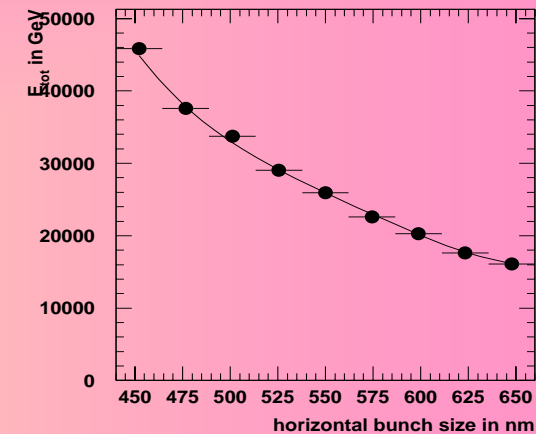
information can be used for feedback

Considered technologies :

- **Diamond-W Sandwich**
- **Gas ionisation chamber**
- **Scintillator crystals**



Deposited energy over  $r$  and  $\phi$  contains information about beam parameters



# Beam Strahlung

## Diagnostics of bunches at IP

3 potential sources of information

- energy-distribution of pairs
- number-distribution of pairs
- distribution of photons

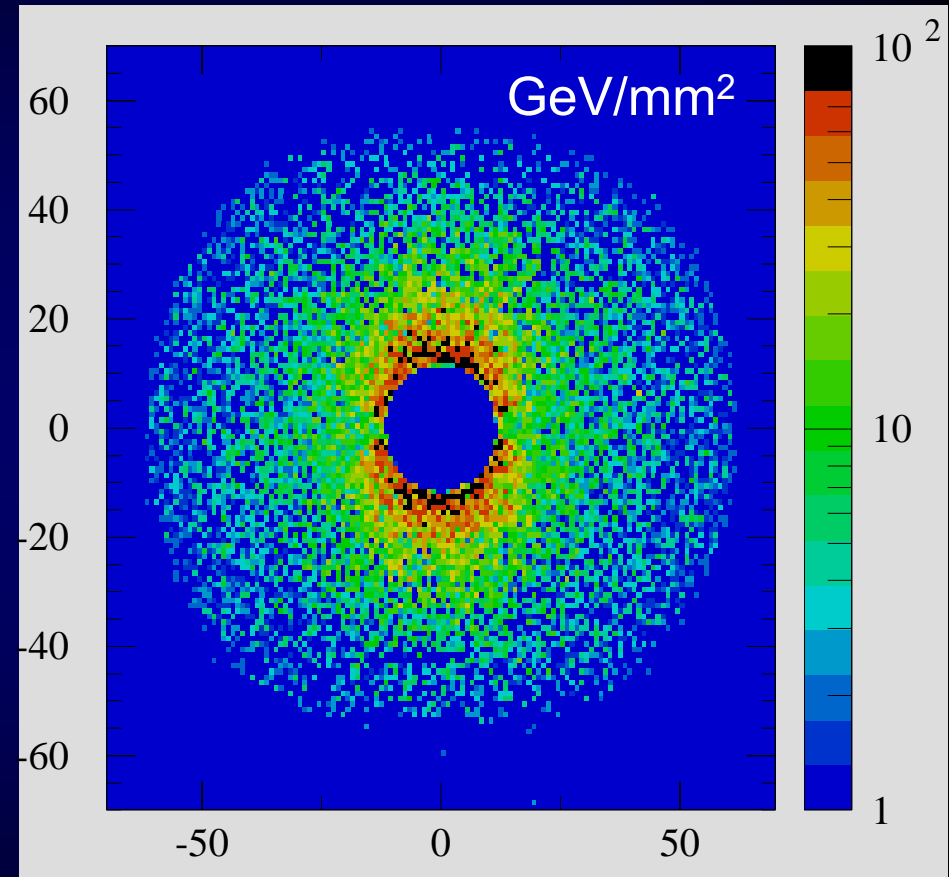
Over-simplified detector simulation

- detectors subdivided into cells
- sum energy impact on cells

main source of uncertainty

→ stat. fluctuations of beam-str.

Linear approximation





## Beam Monitoring -

### Current Analysis Concept

#### Beam Parameters

- determine collision
- creation of beamstr.
- creation of  $e^+e^-$  pairs

guinea-pig

1<sup>st</sup> order Taylor-Exp.



#### Observables

- characterize energy distributions in detectors

analysis program

$$\begin{pmatrix} \text{Observables} \end{pmatrix} = \begin{pmatrix} \text{Observables} \end{pmatrix}_{\text{nom}} + \begin{pmatrix} \text{Taylor} \\ \text{Matrix} \end{pmatrix} * \begin{pmatrix} \Delta \text{ BeamPar} \end{pmatrix}$$

Solve by matrix inversion  
(Moore-Penrose Inverse)



# Beam Monitoring

Single parameter analysis (one free parameter)

	nominal	old	new	norm.	Beam Diag.
Bunch width x Ave.	553 nm	1.2	2.0	1.5	~ 10 %
Diff.		2.8	3.6	2.1	~ 10 %
Bunch width y Ave.	5.0 nm	0.1	0.2	0.2	Shintake
Diff.		0.1	0.5	0.5	Monitor
Bunch length z Ave.	300 $\mu$ m	4.3	7.5	4.3	~ 10 %
Diff.		2.6	3.5	2.7	~ 10 %
Emittance in x Ave.	10.0 mm mrad	1.0	---	---	?
Diff.		0.4	0.7	0.7	?
Emittance in y Ave.	0.03 mm mrad	0.001	0.001	0.001	?
Diff.		0.001	0.004	0.002	?
Beam offset in x	0	7	30	6	5 nm
Beam offset in y	0	0.2	0.6	0.4	0.1 nm
Horizontal waist shift	0 $\mu$ m	80	---	---	None
Vertical waist shift	360 $\mu$ m	20	23	24	None

Good precision - determination of beam parameters look optimistic

# Beam Monitoring

## Multi parameter analysis

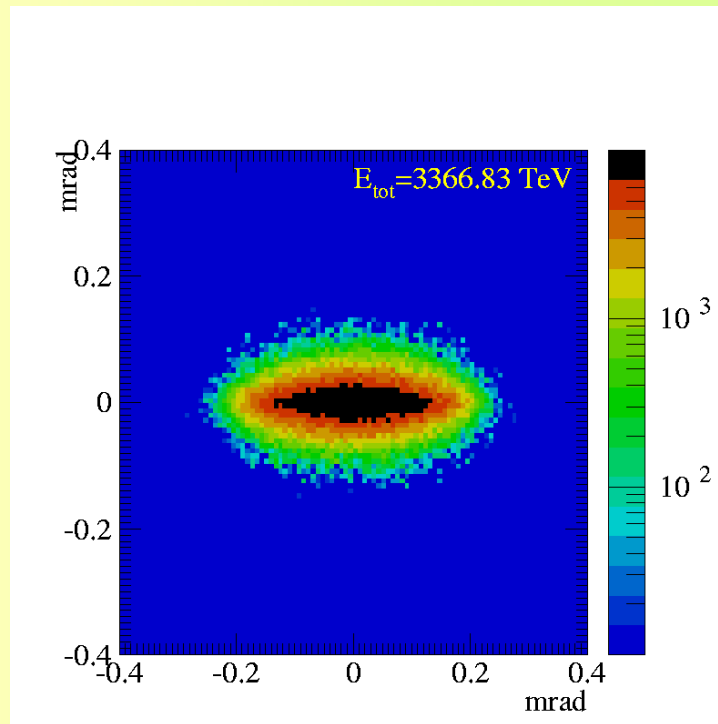
Expected resolutions when 1, 2, 4 or 6 parameters are running.

$\sigma_x$	$\Delta\sigma_x$	$\sigma_y$	$\Delta\sigma_y$	$\sigma_z$	$\Delta\sigma_z$
0.3 %	0.4 %	3.4 %	9.5 %	1.4 %	0.8 %
0.3 %	0.4 %	3.5 %	11 %	1.5 %	0.9 %
0.9 %	1.0 %	11 %	24 %		
		5.7 %	24 %	1.6 %	1.9 %
1.8 %	1.1 %	16 %	27 %	3.2 %	2.1 %

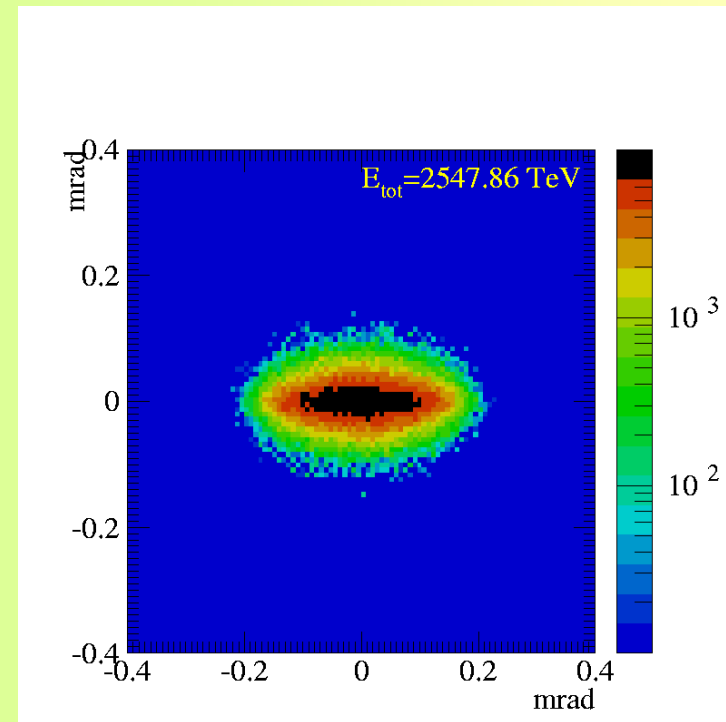
Current analysis → we can measure 6 (more ?) beam parameters simultaneously with reasonably accuracy

# First Look at Photons

Zeuthen



nominal setting  
(550 nm x 5 nm)

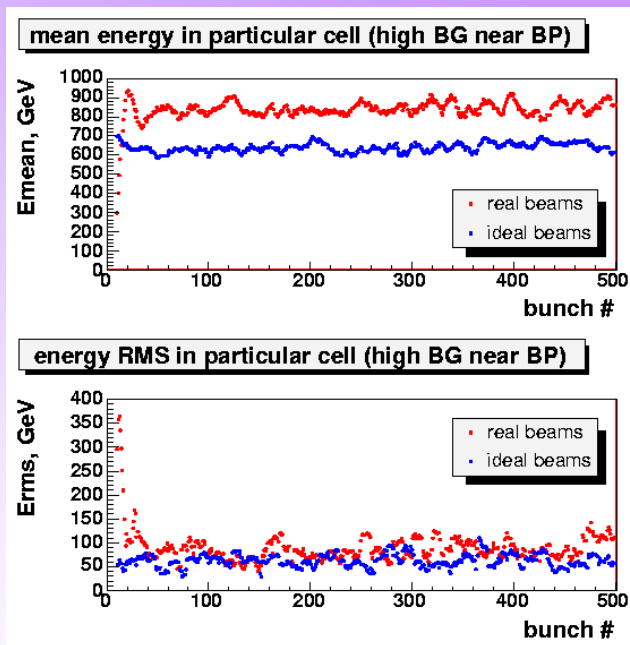


$\sigma_x = 650 \text{ nm}$   
 $\sigma_y = 3 \text{ nm}$

# MC BeamCal - Real Beam simulation

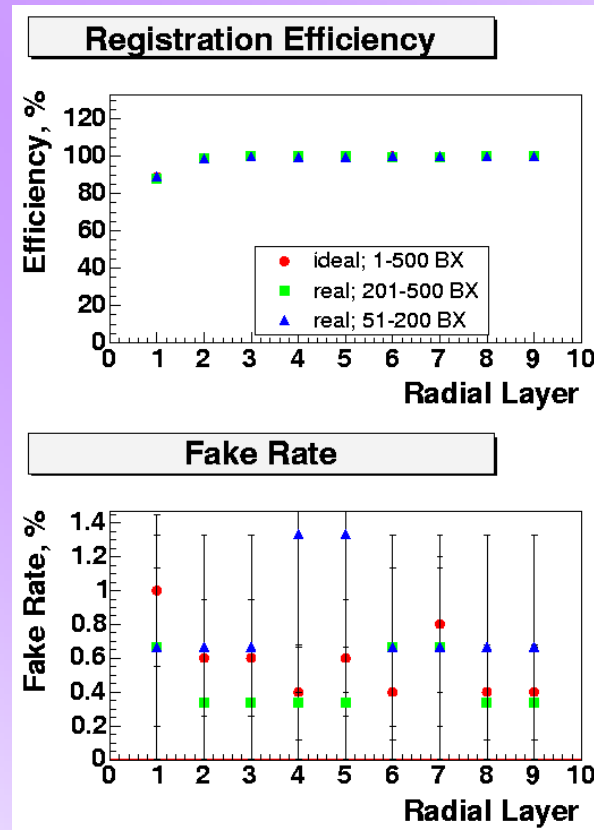
Minsk / Zeuthen

Included in the simulation:  
ground motion,  
feedback system delay,  
emittance growth,  
lumi optimisation



Total energy deposited in one pad of BeamCal near the beampipe is larger for real beam  
Resolution of energy deposition rms is similar

The efficiency to identify a 100 GeV electrons close to the beam is nearly the same for RB and IB



Fake rate resulting from BG fluctuation is on the same level

# LumiCal / BeamCal - Potential Technologies

## Challenge for detectors:

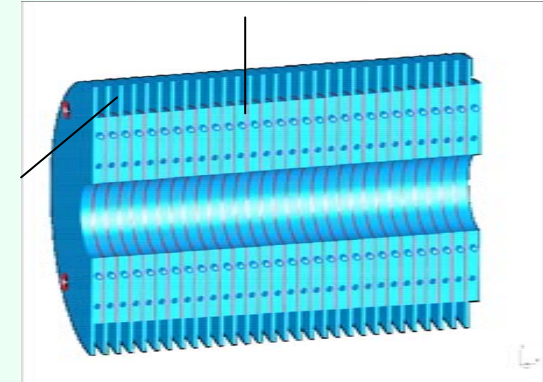
- high precise luminosity measurements
- fast ,online, beam diagnostic and identification high energy electrons and photons
- radiation hard sensors

## Calorimeters R&D →

- Diamond/Silicon – Tungsten (sandwich cal.)

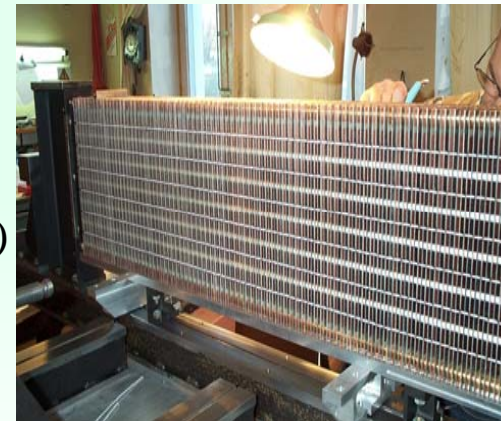
Sensor: Diamond/Silicon

Space for electronics



- Gas Ionisation Chamber – Tungsten (sandwich cal.)

Instead sensor → heavy gas  $C_3F_8$   
to measure energy deposit



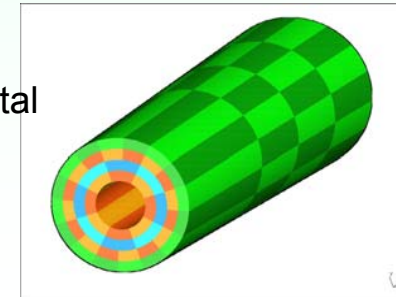
One module

- Heavy Crystal Calorimeter

option with scintillating fibres

option with ultra-thin photo-tiodes

Segments of heavy crystal



## Silicon Facilities:

- Prague
- Cracow
- Zeuthen

# Design consideration

Prague

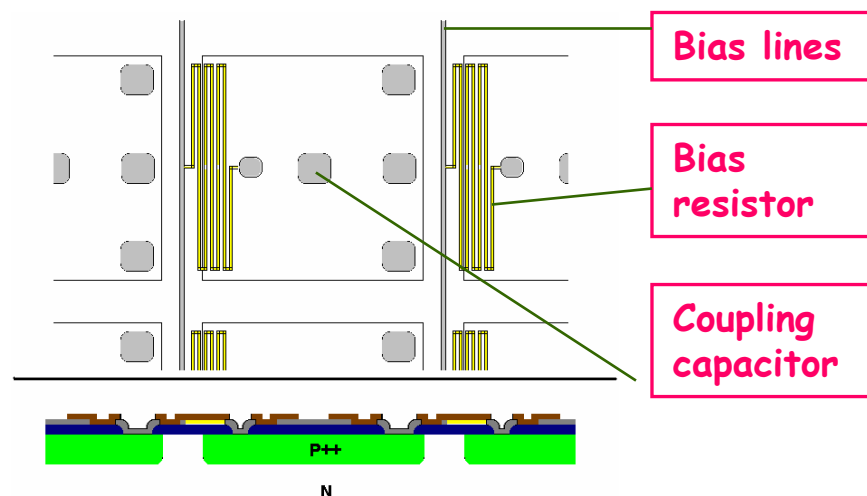
## *a) polysilicon resistors:*

- should not be a problem to have resistors  $\approx 10 \text{ M}\Omega$ ;
- capacitors  $\approx 1\text{-}10 \text{ nF}$ .

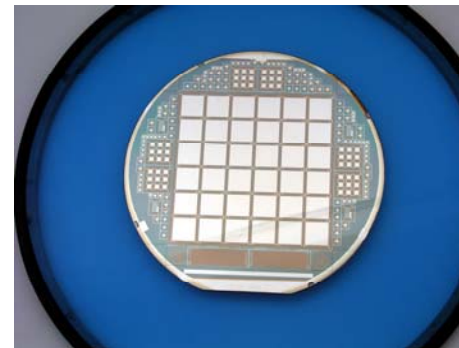
## *b) punch through resistors:*

- resistors to be tested; if acceptable then it is a simple solution;
- capacitors as *a*).

Compatibility of process for variants *a*) and *b*) on one wafer? Option *a*) as a *baseline* for main sensor tile?



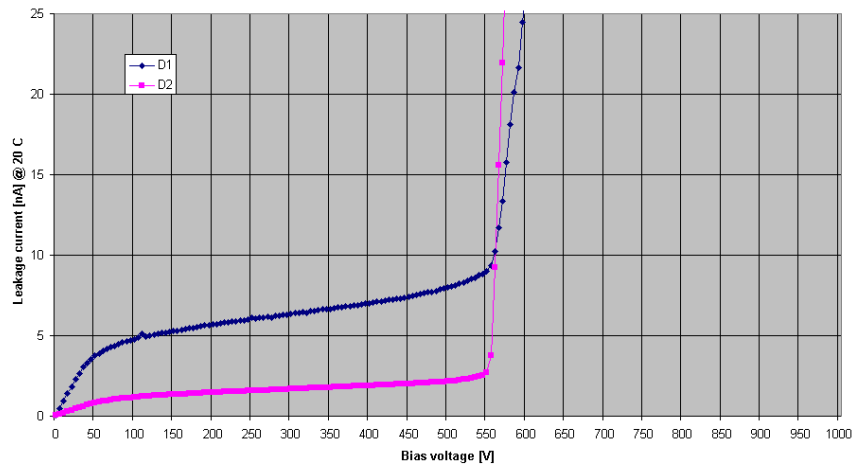
Pre-prototype



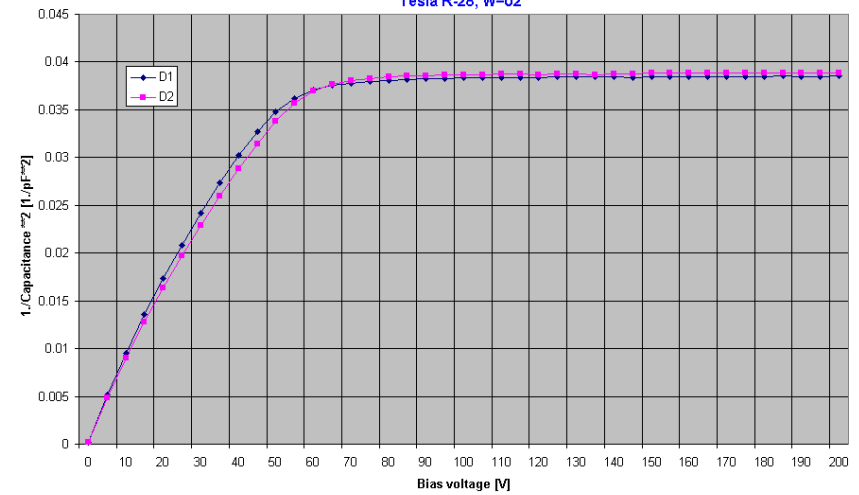


# Electric characterization

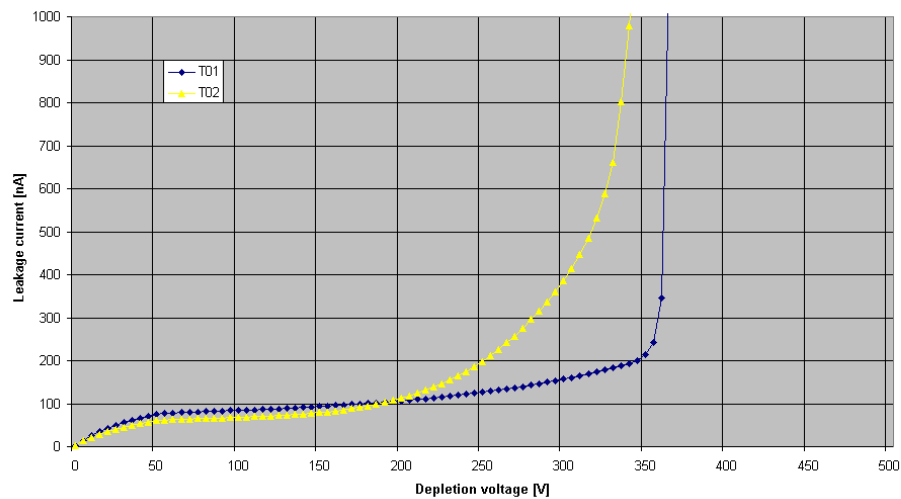
I-V Diode with guardring  
Tesla R-28, W=02



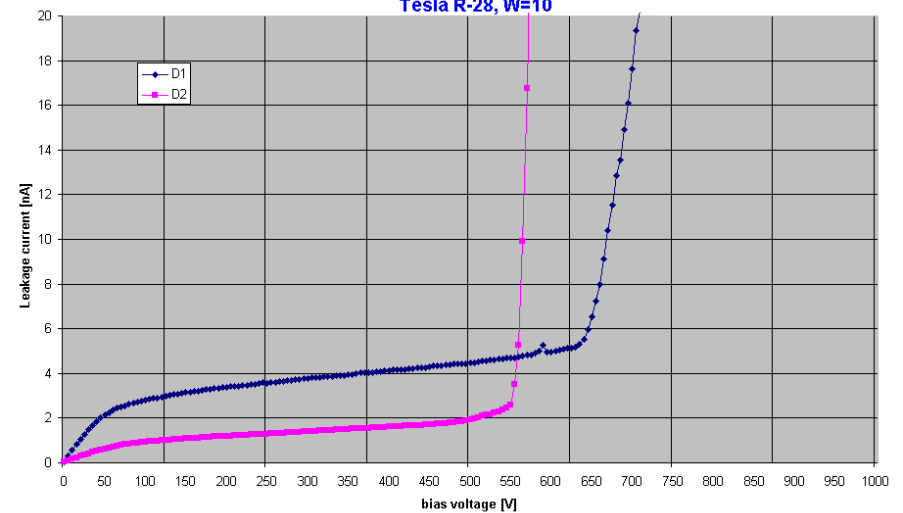
C-V Diode with guardring  
Tesla R-28, W=02



I-V Tiles  
Tesla R-28, W=02



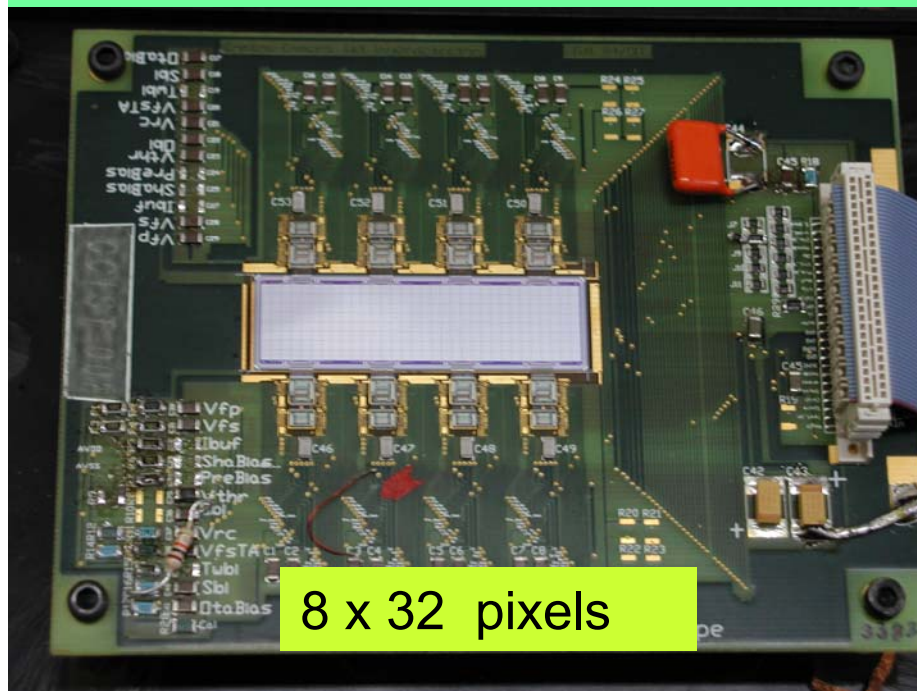
I-V Diode with guardring  
Tesla R-28, W=10



# Silicon sensors

Cracow

- Preamplifier based on Minsk „Tetrode”
- Bonding of silicon samples from Prague
- Testing of the pixel detector
- New preamplifiers ordered



## Next steps:

- Tests of the pixel detector with source
- Tests of the silicon diode samples
- Preamplifiers based on AmpTek chips

At **DESY Zeuthen** we are able to perform (class 10k clean room):

- Ultrasonic wire bonding (Au, Al, down to 17.5 µm wires)
  - Glueing with high mechanical precision and/or special hardening procedures (silver epoxies)
  - Measurements of single and double sided sensors on different probe stations
  - long term measurements (darkness, special atmosphere: N<sub>2</sub> or similar)
  - chip testing (delivered probe cards can be adapted)
- additional:       electronics workshop with automatic SMD placement and soldering tools  
                          mechanical workshop with NC machining/milling  
                          at **DESY Hamburg** a 'state of the art' programmable wire bonder

Companies / Institutions we are used to work with:

- Sensors: CiS Erfurt (D), Micron Ltd. (UK), SINTEF Oslo (N), Hamamatsu (J)
- chip design: IDE AS, Oslo (N) and ASIC Laboratory of University of Heidelberg (D)
- probe cards: Wentworth Deutschland GmbH, München (D)
- high precision printed circuit boards: Würth GmbH, Roth am See (D), Optiprint (CH)
- thick film hybrids: Elbau GmbH, Berlin (D)

# Position Measurement with Laser and CCD Camera

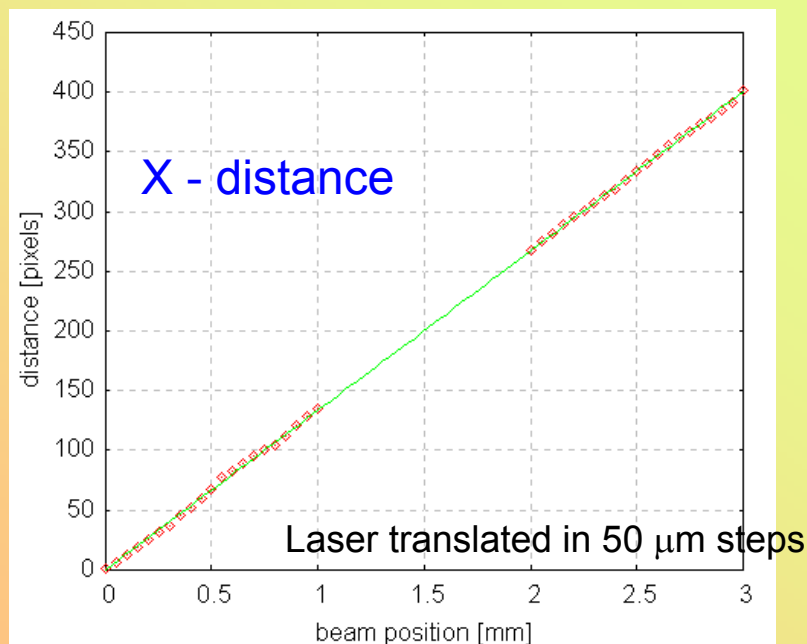
Cracow

## Requirements on alignment:

Inner Radius of LumiCal  $< 1 \mu\text{m}$   
Axial LumiCal position  $< 60 \mu\text{m}$



Reconstruction of He-Ne red laser spot on CCD camera



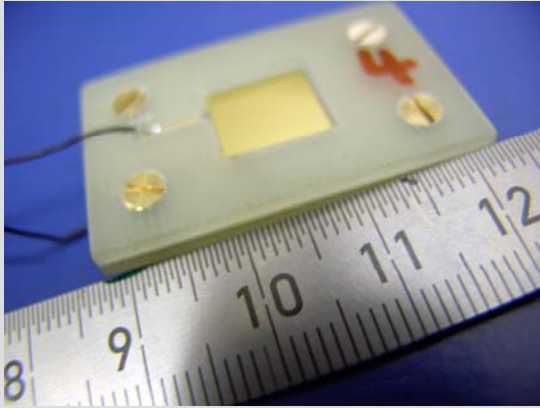
## Next steps:

- Small-pixel camera, CCD technical data,
- Manually controlled sensitivity, BW camera,
- Micro pointing stability of lasers,
- Semiconductor laser,
- Piezzoelectric movement of camera,
- More statistics.

possible resolution of  $\sim 1 \mu\text{m}$  if the center of the light spot is determined with accuracy better than 0.1 pixel

# Diamond Sensors

Zeuthen



CVD diamonds from  
Fraunhofer Inst. Freiburg  
12 samples (12 x 12 mm)  
300 and 200  $\mu\text{m}$   
different surface treatments:  
#1 – substrate side polished; 300  $\mu\text{m}$   
#2 – substrate removed; 200  $\mu\text{m}$   
#3 – growth side polished; 300  $\mu\text{m}$   
#4 – both sides polished; 300  $\mu\text{m}$   
metallisation: 10 nm Ti + 400 nm Au

Measured:

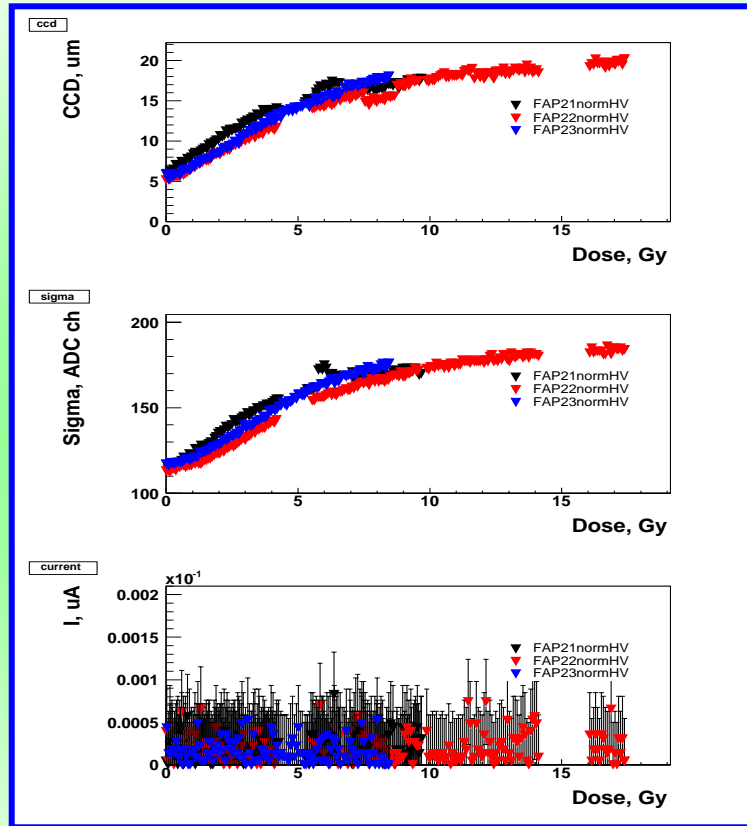
- I-V characteristics
- Charge collection distance (CCD) – not irradiated samples
- CCD – irradiation studies

## CCD – irradiation, purities studies and beam tests

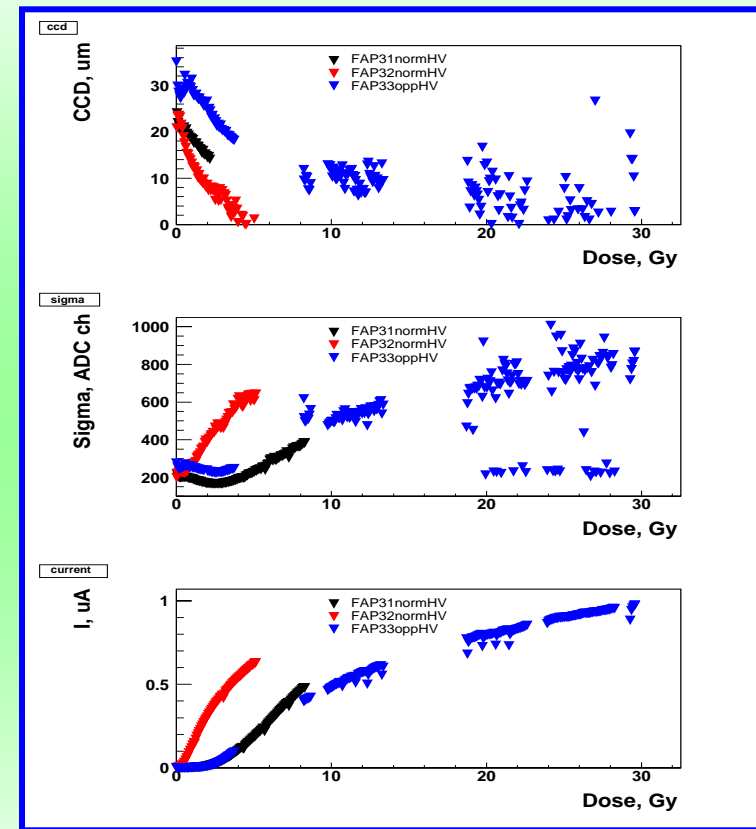
- ✓ The samples were irradiated with Sr-source with estimated dose-rate of about 0.45 Gray per hour
- ✓ The total absorbed dose for all the samples was at least 5 Gy.
- ✓ Parameters monitored during the irradiation:
  - Sr-spectrum peak position
  - width of the peak (->noise)
  - current in HV-circuit
  - test pulse from a generator (-> electronics stability)
- ✓ Raman spectroscopy and photoluminescence analysis
  - no nitrogen, no silicon found
- ✓ Tests on electron beam prepared for May

# CCD – irradiation studies

## Examples



Group #2 (substrate side removed).  
HV = 200V



Group #3 (growth side polished).  
HV = 300V

In general Group #2 can work as detector



# Diamonds

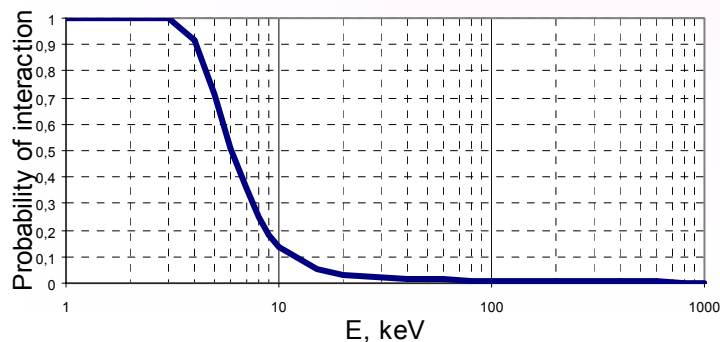
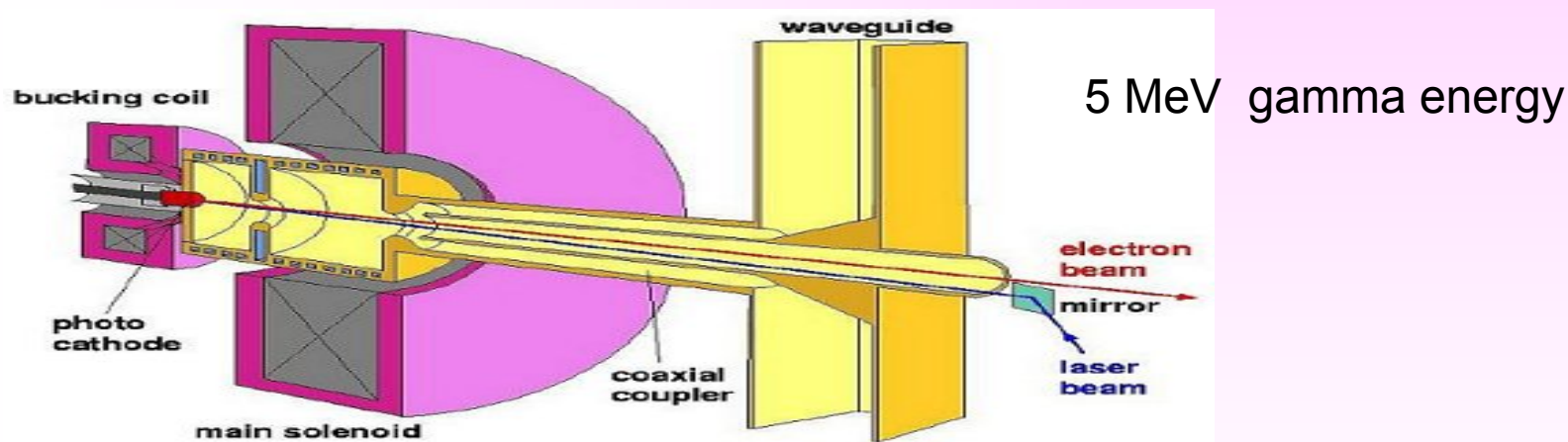
Minsk

Current step: Laboratory tests with  $^{90}\text{Sr}$ : Charge collection efficiency of 20%

Readout electronics ready for beam tests

Next step: First prototype for beam tests

Beam tests planned: PITZ / Zeuthen, CERN, HERA, TTF2



Probability of photon interaction within  
300  $\mu\text{m}$  of diamond sensor

# CVD Diamonds

NSC GPI – Moscow / Dubna

Diamonds disks: 57 mm diameter, 250 and 350  $\mu\text{m}$  thickness, laser cut, polished both sides, metallized Cr/Au electrodes deposited to growth and substrate side sides to compare their quality

## The purity and optical properties

**Impurities content** → measur. the optical transmission spectra - UV visible and IR range

**The diamond quality** → measur. of the spectral photoresponse in UV-visible (200-225 nm) range.

Ratio of photoresponse (UV to visible range) says about diamond quality –higher when this ratio increasing



MPCVD device for diamond deposition

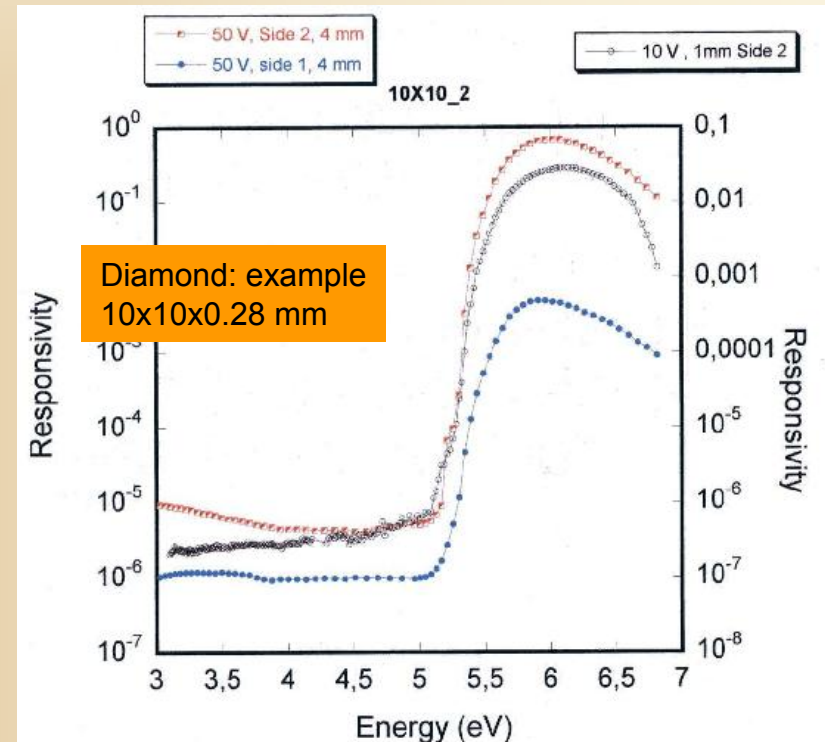
Spectral photoresponse measured separately for **growth** and **substrate side** side

The spectral discrimination  
~six orders of magnitude for growth side  
Two order of magnitude lower for substrate side → more defective structure

Preparation for ionization radiation tests (Dubna)  
(alpha and beta spectra)

5 new diamond samples are available now (thickness: 110, 280, 290, 380, 380 microns)

The measur. of optical properties, purity, I-V characteristics and irradiation tests are under the work



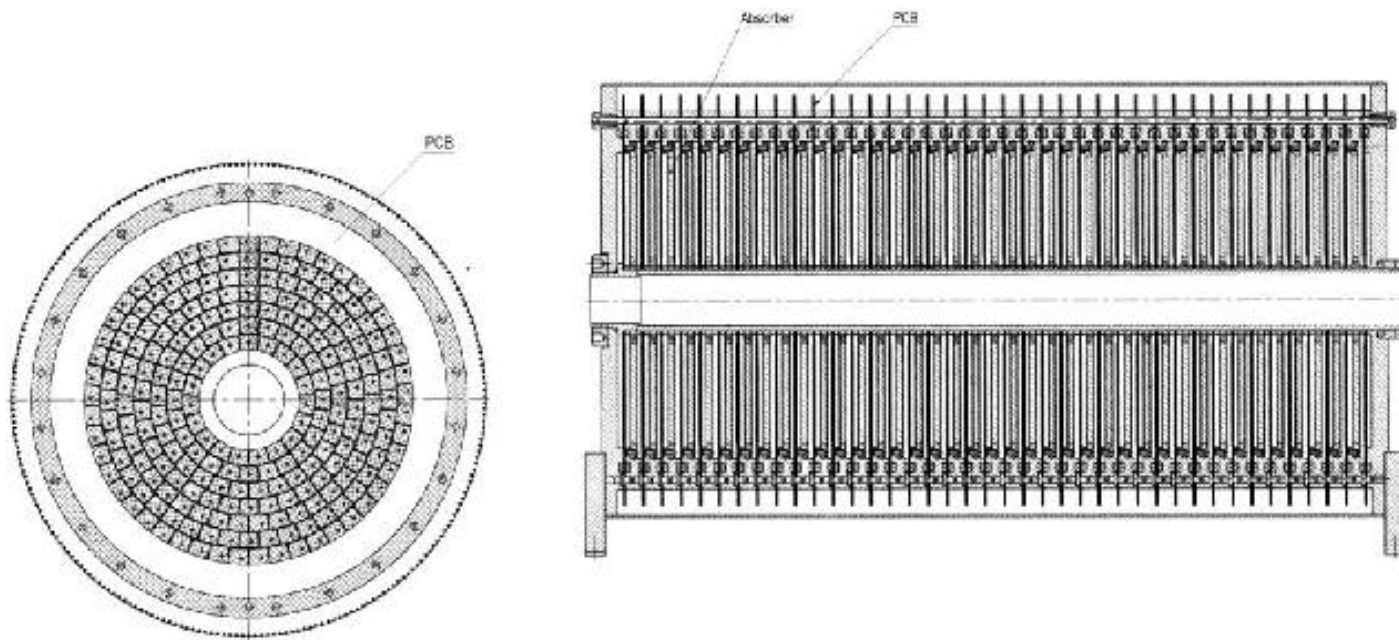
# Gas Ionization Calorimeter W / $C_3F_8$

Protvino

- W /  $C_3F_8$  Cal.** →
- good energy resolution
  - high uniformity and stability
  - simple calibration
  - high radiation hardness
  - low equivalent noise energy also at atm. pressure
  - low cost

$C_3F_8$  (octa fluoro propane )  
measurements:  
density 0.0075 g/cm<sup>3</sup>  
molecular weight 188  
drift velocity  $v = 0.07$ mm / ns  
at  $\sim 800$  V / atm

The volumes between absorber plates (W) are filled with gas  $C_3F_8$  at 0.5 and higher atm pressure

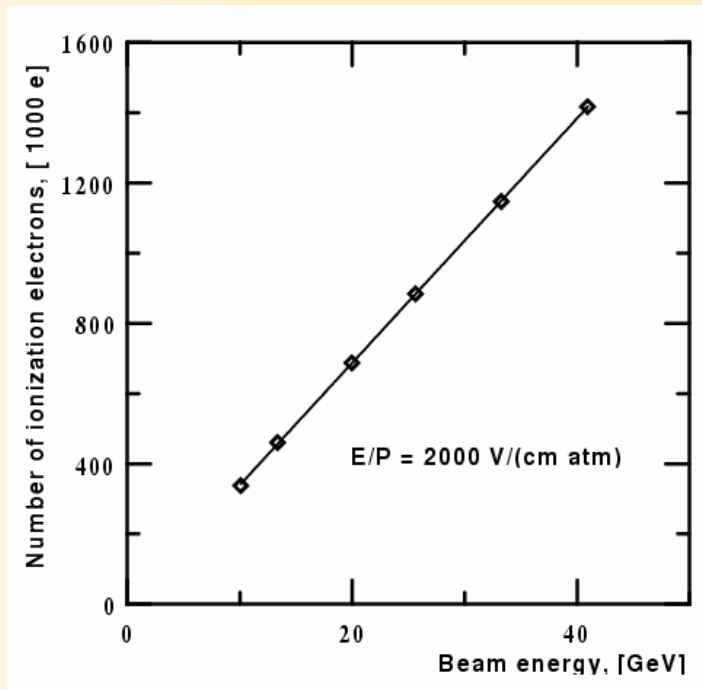


Pressure vessel  
with the readout  
connectors

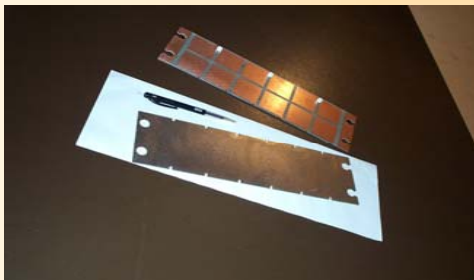


## Gas Ionization Calorimeter W / $C_3F_8$

- Beam tests of prototypes with electrons up to 70 GeV (IHEP Protvino) at pressure up to 1.8 atm, lead absorber - 1.5 and 3 mm, 10mm gas bigap

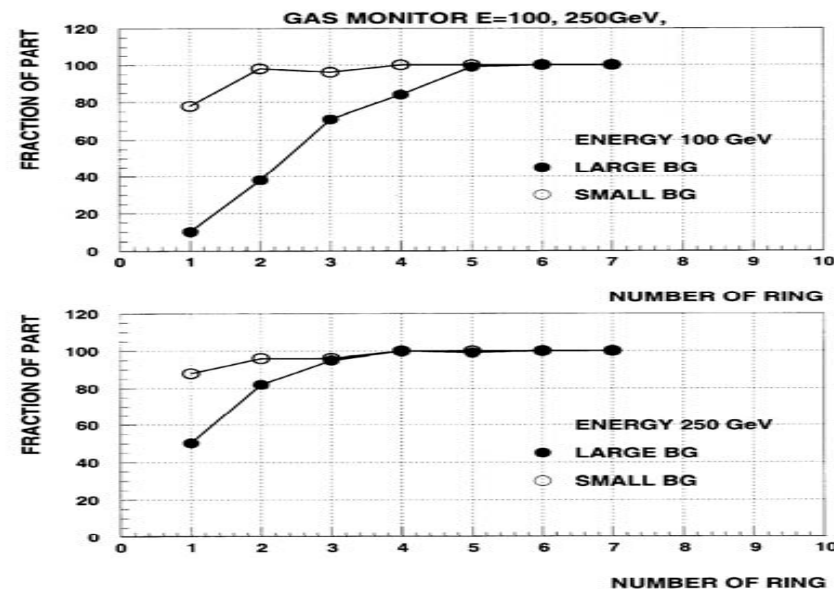


PCB with redout pads  
to collect the ionization electrons



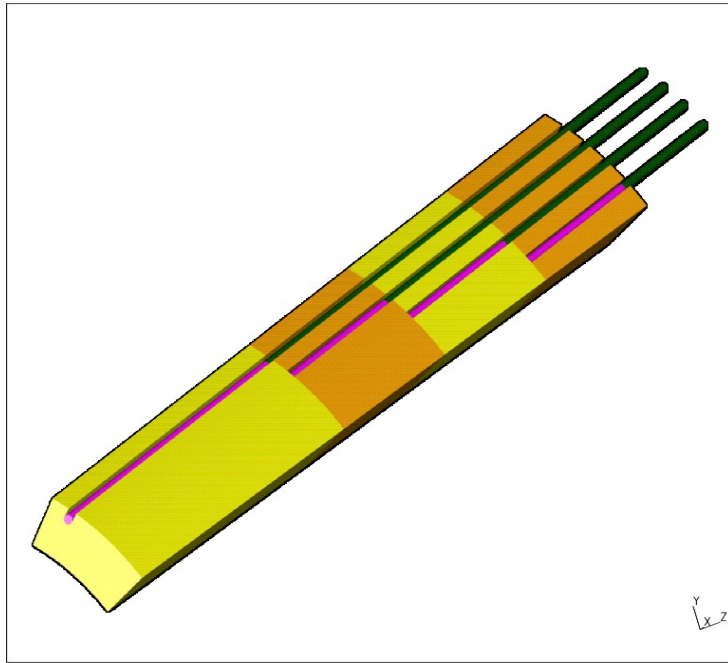
- MC simulation – Tungsten as absorber

Efficiency to identify high energy electron  
- small and large background



## Crystal Calorimeter Option for BeamCal

Expectation : homogeneous crystal calorimeter –  
better energy and time resolution than a sandwich calorimeter



Individual fiber readout for every  
crystal segment

Example :  $\text{PbWO}_4$  –  
Moliere radius  $\sim 2.3$  cm

Readout via fibers reduces light yield to 14 %

# Conclusions

The recent developments indicate on  
essential progress in most areas